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Vishay Siliconix

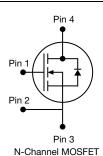
HALOGEN

FREE

E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.332				
Q _g max. (nC)	70				
Q _{gs} (nC)	8				
Q _{gd} (nC)	15				
Configuration	Sing	le			





FEATURES

- · Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH11N65EF-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V_{DS}	650	V	
Gate-Source Voltage	V_{GS}	± 30	7 V	
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$		11	А
	V_{GS} at 10 V $T_C = 100 ^{\circ}C$	ID	7	
Pulsed Drain Current ^a	I _{DM}	27		
Linear Derating Factor			1	W/°C
Single Pulse Avalanche Energy ^b		E _{AS}	127	mJ
Maximum Power Dissipation	P_{D}	130	W	
Operating Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	ppe T _J = 125 °C		70	1//20
Reverse Diode dV/dt c	dV/dt	26	V/ns	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3 A.
- c. $I_{SD} \leq I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum Junction-to-Ambient	R _{thJA}	42	55	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	0.72	0.96	C/VV		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
0.1. 0		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Z. o. O. I. Vallana Buria O anal		V _{DS} =	$V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.332	0.382	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 6 A	-	4.6	-	S
Dynamic		•					
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1243	-	
Output Capacitance	C _{oss}	Τ,	V _{DS} = 100 V,	-	62	-	
Reverse Transfer Capacitance	C _{rss}	7	f = 1 MHz	-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	., .,		-	44	-	pF
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$	$V_{DS} = 0$	/ to 520 V, V _{GS} = 0 V	-	171	-	
Total Gate Charge	Qg			-	35	70	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 6 A, V_{DS} = 520 V$	-	8	-	nC
Gate-Drain Charge	Q _{gd}	1		-	15	-	
Turn-On Delay Time	t _{d(on)}			-	19	38	
Rise Time	t _r	V _{DD} :	= 520 V, I _D = 6 A,	-	26	52	
Turn-Off Delay Time	t _{d(off)}		$= 10 \text{ V}, R_g = 9.1 \Omega$	-	43	86	ns
Fall Time	t _f	7		-	25	50	1
Gate Input Resistance	R _g	f = 1	MHz, open drain	0.4	0.7	1.4	Ω
Drain-Source Body Diode Characteristic		•				•	
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	11	_
Pulsed Diode Forward Current	I _{SM}	integral revers		-	-	21	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	108	216	ns
Reverse Recovery Charge	Q _{rr}		5 °C, I _F = I _S = 6 A, 100 A/µs, V _B = 25 V	-	0.5	1.0	μC
Reverse Recovery Current	I _{RRM}	ui/ut =	100 AV Ho, VK = 70 A	-	9.6	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

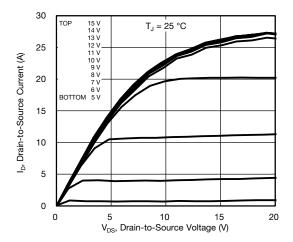


Fig. 1 - Typical Output Characteristics

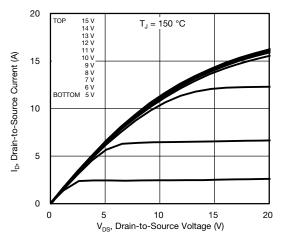


Fig. 2 - Typical Output Characteristics

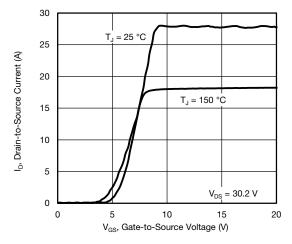


Fig. 3 - Typical Transfer Characteristics

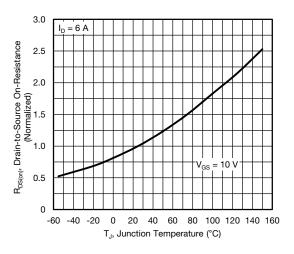


Fig. 4 - Normalized On-Resistance vs. Temperature

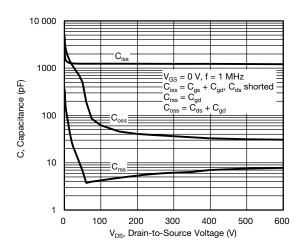


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

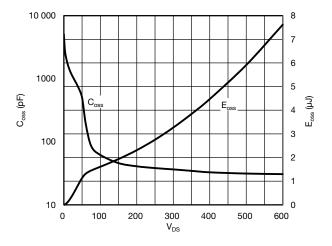


Fig. 6 - $C_{\mbox{\scriptsize OSS}}$ and $E_{\mbox{\scriptsize OSS}}$ vs. $V_{\mbox{\scriptsize DS}}$



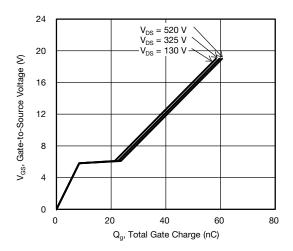


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

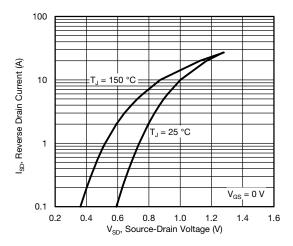


Fig. 8 - Typical Source-Drain Diode Forward Voltage

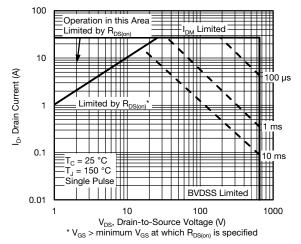


Fig. 9 - Maximum Safe Operating Area

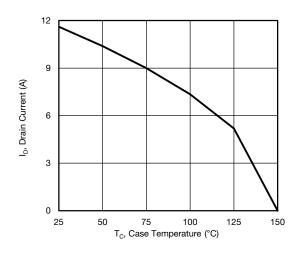


Fig. 10 - Maximum Drain Current vs. Case Temperature

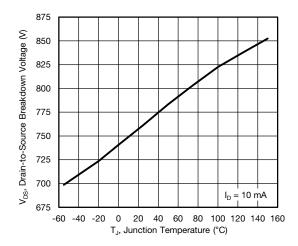


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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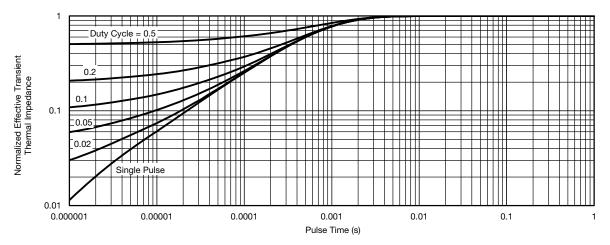


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

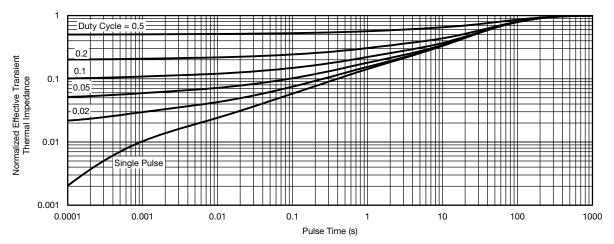


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

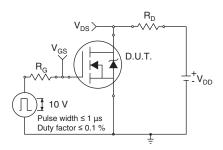


Fig. 14 - Switching Time Test Circuit

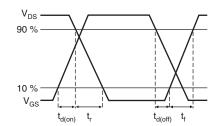


Fig. 15 - Switching Time Waveforms

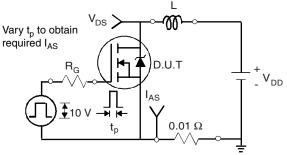


Fig. 16 - Unclamped Inductive Test Circuit

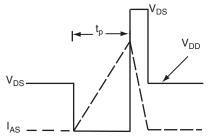


Fig. 17 - Unclamped Inductive Waveforms



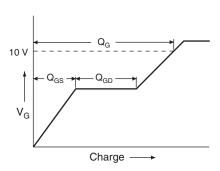


Fig. 18 - Basic Gate Charge Waveform

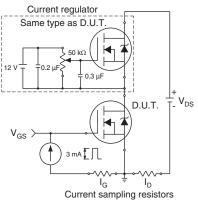
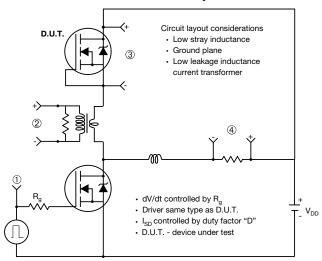


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



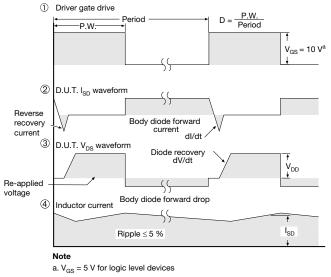


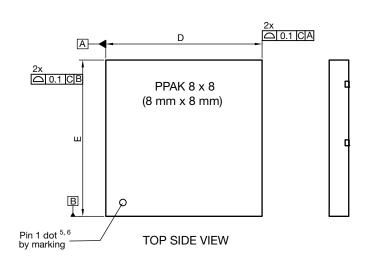
Fig. 20 - For N-Channel

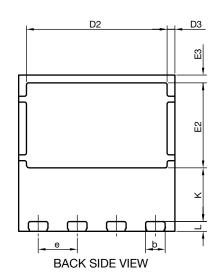
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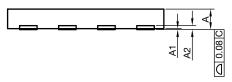


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PowerPAK® 8 x 8 Case Outline







DIM	MILLIMETERS		INCHES			
DIM. MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2	020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3	0.40 BSC		0.016 BSC			
е	2.00 BSC		0.079 BSC			
E	7.90	7.90 8.00 8.10		0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC		0.016 BSC			
K	2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022
N ⁽³⁾	8				8	

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

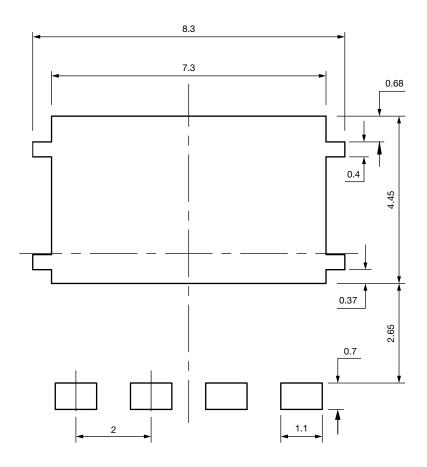
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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